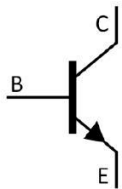
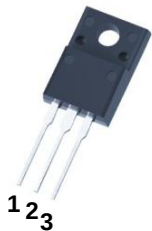


**/ Descriptions****/ Features****/ Applications****/ Equivalent Circuit****/ Pinning****/  $h_{FE}$  Classifications & Marking**

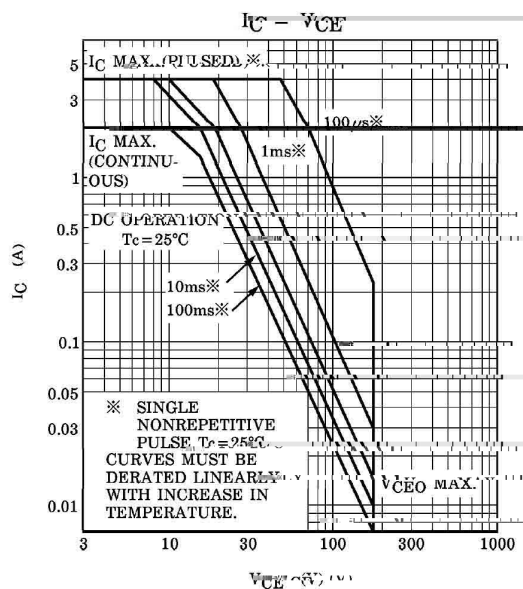
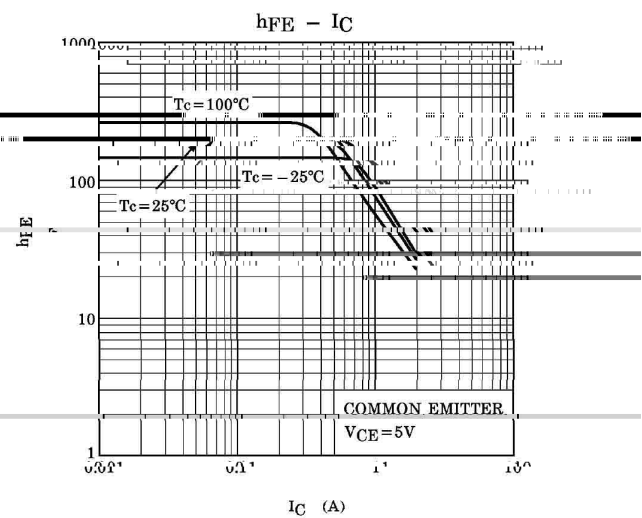
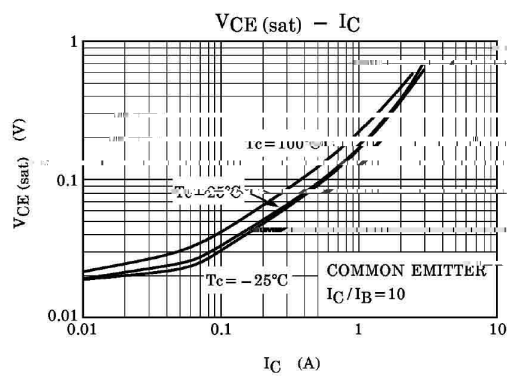
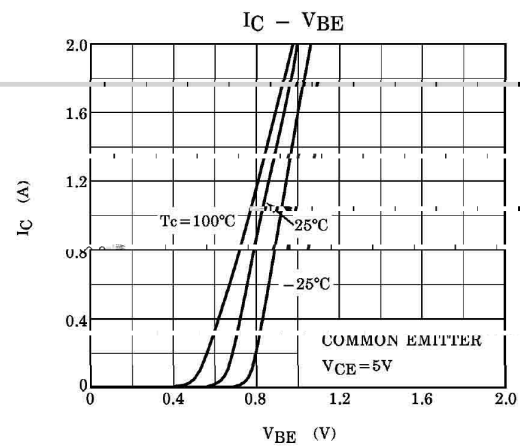
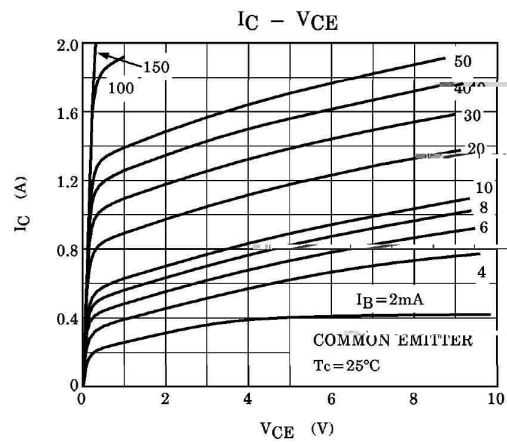
/ Absolute Maximum Ratings(Ta=25 )

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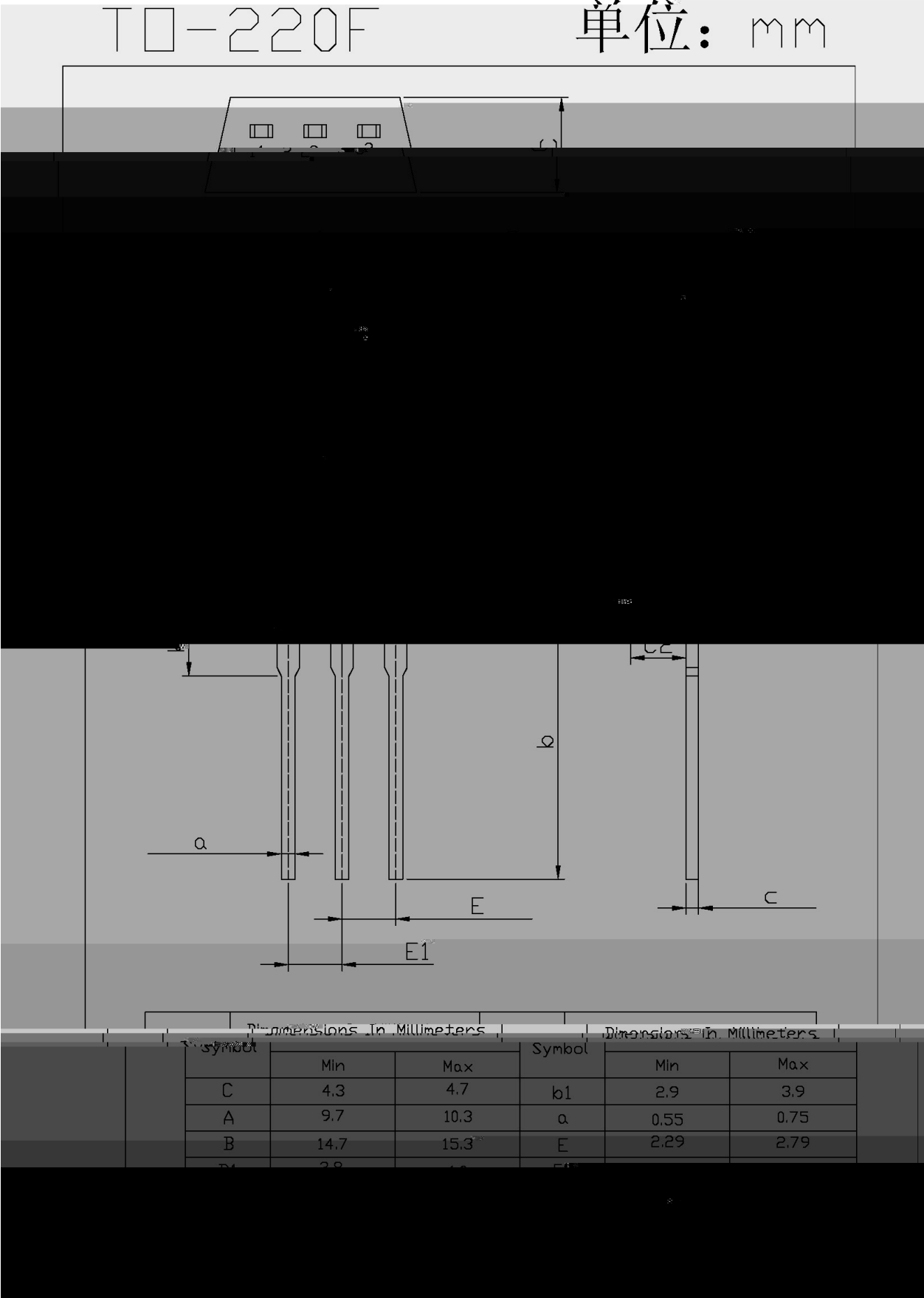
/ Electrical Characteristics(Ta=25 )

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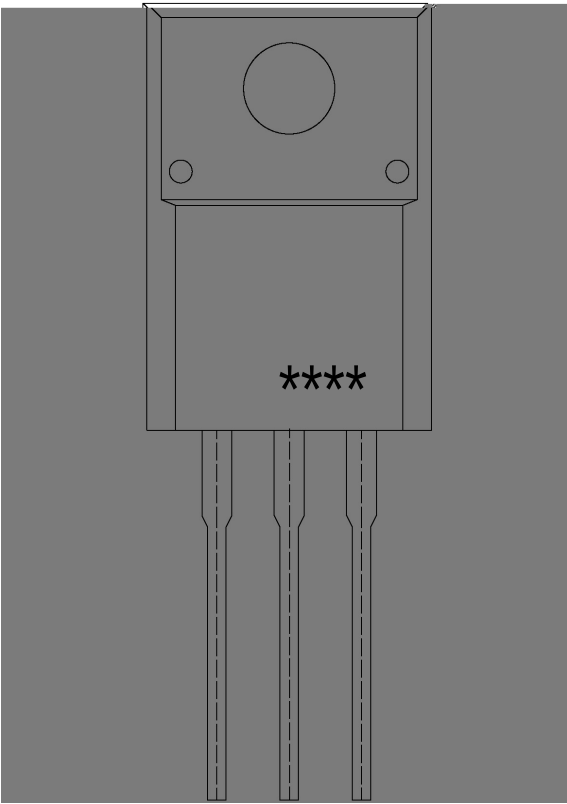
## / Electrical Characteristic Curve



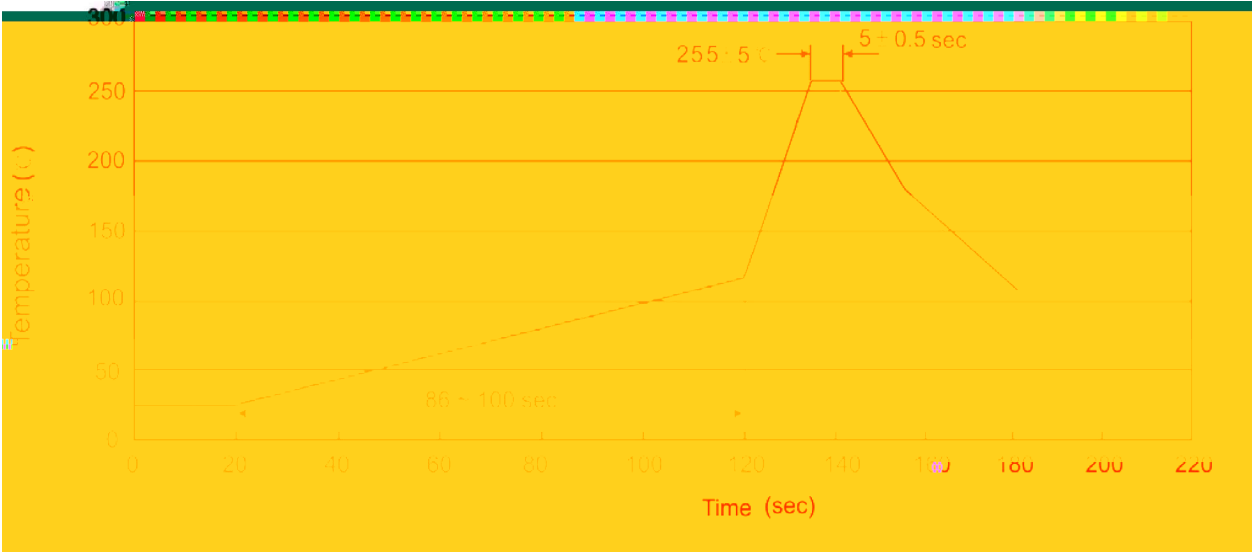
/ Package Dimensions



/ Marking Instructions



( ) / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

℃

/ Packaging SPEC.

| 封装形式 | 包装数量             |                       |                        | 包装尺寸 |      |      |
|------|------------------|-----------------------|------------------------|------|------|------|
|      | Units/Bag<br>只/袋 | Bags/Inner Box<br>袋/盒 | Units/Inner Box<br>只/盒 | mm   | mm   | mm   |
|      | 1000             | 10                    | 10000                  | 16.6 | 6.48 | 2.74 |